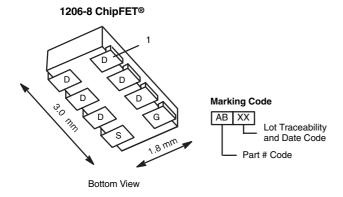


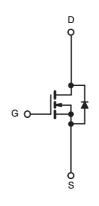
N-Channel 2.5-V (G-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)			
20	$0.030 \text{ at V}_{GS} = 4.5 \text{ V}$	7.2			
	0.045 at $V_{GS} = 2.5 \text{ V}$	5.9			

FEATURES

- TrenchFET[®] Power MOSFETs
- 2.5 V Rated





N-Channel MOSFET

Ordering Information: Si5404DC-T1

ABSOLUTE MAXIMUM RATINGS	5 T _A = 25 °C, unle	ess otherwise	noted		
Parameter		Symbol	5 sec	Steady State	Unit
Drain-Source Voltage		V _{DS}	20		V
Gate-Source Voltage		V_{GS}	± 12		
Continuous Dunin Comment /T 450 °C)	T _A = 25 °C	- I _D	7.2	5.2	٨
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		5.2	3.8	
Pulsed Drain Current		I _{DM}	20		Α
Continuous Source Current (Diode Conduction) ^a		I _S	2.1	1.1	
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	2.5	1.3	W
	T _A = 85 °C		1.3	0.7	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature)b, c			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian de Ambienta	t ≤ 5 sec	R _{thJA}	40	50	°C/W
Maximum Junction-to-Ambient ^a	Steady State		80	95	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	15	20	

Notes:

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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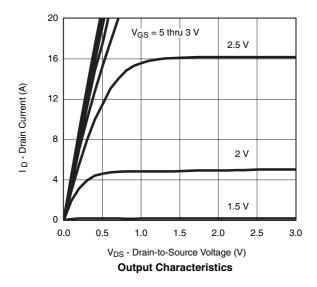
SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.6			V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V			1	μА		
		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 85 °C			5			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20			Α		
Drain-Source On-State Resistance ^a	r	$V_{GS} = 4.5 \text{ V}, I_D = 5.2 \text{ A}$		0.025	0.030	0		
	r _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 4.3 \text{ A}$		0.038	0.045	Ω		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 5.2 A		20		S		
Diode Forward Voltage ^a	V_{SD}	I _S = 1.1 A, V _{GS} = 0 V		0.8	1.2	V		
Dynamic ^b	,			-				
Total Gate Charge	Q_g			12	18			
Gate-Source Charge	Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5.2 \text{ A}$		2.4		nC		
Gate-Drain Charge	Q _{gd}			3.2		1		
Turn-On Delay Time	t _{d(on)}			20	30			
Rise Time	t _r	V_{DD} = 10 V, R_L = 10 Ω		40	60	ns		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 4.5 V, R_G = 6 Ω		40	60			
Fall Time	t _f			15	23			
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 1.1 A, di/dt = 100 A/μs		30	60			

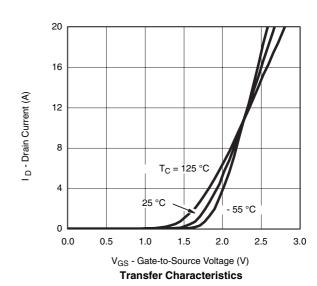
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C unless noted



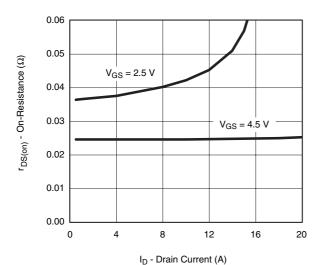




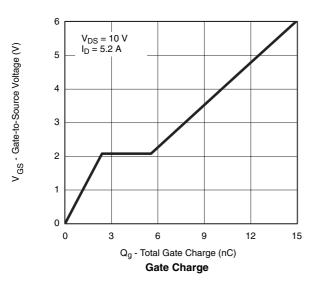




TYPICAL CHARACTERISTICS 25 °C unless noted



On-Resistance vs. Drain Current



T_J = 150 °C

T_J = 150 °C

T_J = 25 °C

T_J = 25 °C

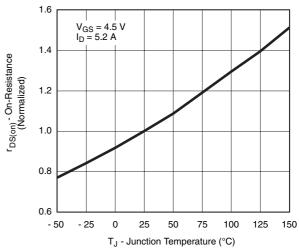
V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

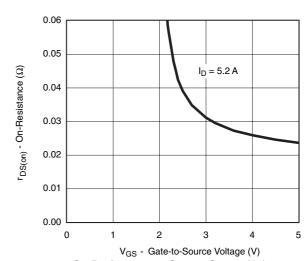
1800
1500
Ciss
1200
900
600
Crss
0
0
4
8
12
16
20

V_{DS} - Drain-to-Source Voltage (V)





On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

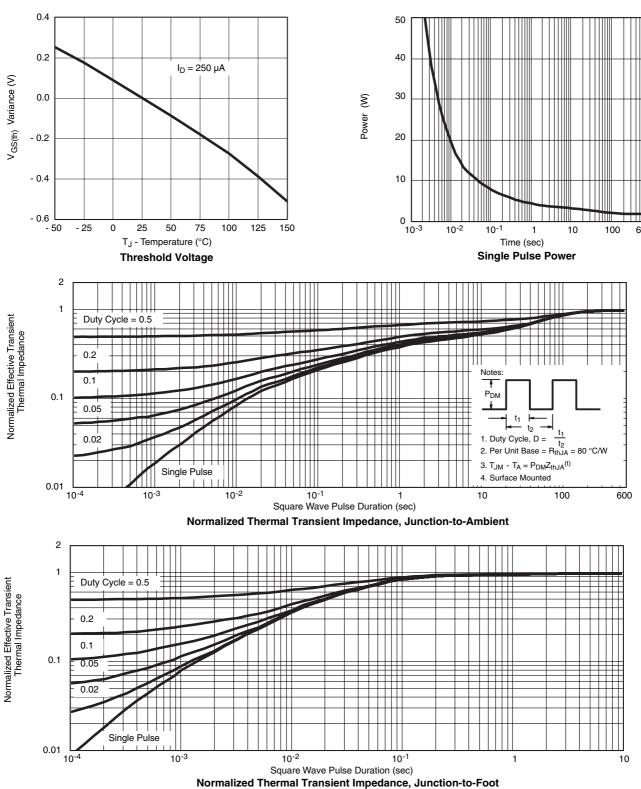
20

S - Source Current (A)

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TYPICAL CHARACTERISTICS 25 °C unless noted



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